	iconnecto	
	SPECIFICATIO	N
宏到	太電子股份有	限公司
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	Taoyuan County 320, Taiwan (R	2.0.C.)
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SPEC. NO.:	R	EVISION: <u>A1</u>
PRODUCT NAME:	0.8mm H=15.0mm BOARD T	O BOARD CONNECTOR
PRODUCT NO:	51065 \ 51066 \ 52021 SER	ES
PREPARED:	CHECKED:	APPROVED:
Zhu,si biao	Lu,jing quan	Hsieh,fu yu
DATE: 2023/02/15	DATE: 2023/02/15	DATE: 2023/02/15

2010/10/31 TR-FM-73015L

		Aces P	N: 51065 series	
TITLE:	0.8mm H=15.0 mm	BOARD TO BOARD C	ONNECTOR	
RELEASE	DATE: 2019/05/07	REVISION: A1	ECN No: ECN-011371	PAGE: 2 OF 8
1 2 3 4 5 6 7	SCOPE APPLICABLE DO REQUIREMENTS PERFORMANCE INFRARED REFL	OCUMENTS S OW CONDITION	EST SEQUENCE	

Aces P/N:	51065 series	
BOARD TO BOARD CON	INECTOR	
REVISION: A1	ECN No: ECN-011371	PAGE: 3 OF 8
	BOARD TO BOARD CON	Aces P/N: 51065 series BOARD TO BOARD CONNECTOR ECN NO: ECN-011371

1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
1	ECN-1805365	NEW SPEC	Liang,lin ji	2018/05/27
А	ECN-1905122	Final "1" → "A"	Liang,lin ji	2019/05/07
A1	ECN-011371	ADD 52021 SERIES	Zhu,si biao	2023/02/15

				Aces P/N:	51065 serie	S	
Т	ITLE: 0.8mm H=	=15.0 mm BC	DARD TO BO		IECTOR		
REL	EASE DATE: 2019/05	i/07 RI	EVISION: A1		ECN No: ECN-0	11371	PAGE: 4 OF 8
2	SCOPE This specifica H=15.0mm b		•		and quality red	quirements	for 0.8mm
3	EIA-364: ELE		_	RIES ASS	SOCIATION		
4	REQUIREMI	ENTS					
	4.1 Design and	Constructio	n				
			be of design oduct drawin		ion and physica	al dimensions	specified on
					d the standard o	depends on T	Q-WI-140101.
	4.2 Materials a	nd Finish					
		inish: (a) (b)		a: Refer to Refer to th		Bronze)	
	4.2.2 H				lastic High Tem	p., UL94V-0	
	4.3 Ratings						
	4.3.2 Vol 4.3.3 Cui	tage: 50 Vo rrent: 0.5 Ar	e Less than Its AC/DC (p nperes (per perature : -4	er pin) · pin)			

	Aces P/N: 51065 S	eries
: 0.8mm H=15.0 mm BOA	RD TO BOARD CONNECTOR	
E DATE: 2019/05/07 REV	SION: A1 ECN No:	ECN-011371 PAGE: 5 OI
erformance		
. Test Requirements and	d Procedures Summary	
Item	Requirement	Standard
Examination of Product	Product shall meet requirement	
	ELECTRICAL	
Item	Requirement	Standard
Low Level Contact Resistance	$50 \text{ m } \Omega$ Max.(initial)per contact $\triangle R$ 20 m Ω Max.	Mate connectors, measure by dry
Insulation Resistance	500 M Ω Min. initial 100 M Ω Min. final	Unmated connectors, apply 250 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	150 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°((EIA-364- 70,METHOD1,CONDITION1)
	MECHANICAL	
Item	Requirement	Standard
Durability	60 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)
Mating / Unmating Forces	Mating Force: 0.07kgf * n (CKT) Max. Unmating Force: 0.015kgf * n (CKT) Min.	Operation Speed : 25.4 ± 3 mm/minute. Measure the force required to mate/unmate connector. (EIA-364-13)

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Aces P/N: 51065 series

TITLE: 0.8mm H=15.0 mm BOARD TO BOARD CONNECTOR

RELEASE DATE: 2019/05/07 REVISION: A1

ECN No: ECN-011371

PAGE: 6 OF 8

MECHANICAL						
ltem	Requirement	Standard				
Contact Retention Force	150gf Min.	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.				
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)				
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)				

ENVIRONMENTAL						
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 4 (Lead Free)	Pre Heat:150℃~180℃, 60~120sec. Heat : 230℃ Min., 40sec Min. Peak Temp. : 260℃ Max,				
		10sec Max.				
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, test condition I)				
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)				

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RELEASE DATE: 2019/05/07

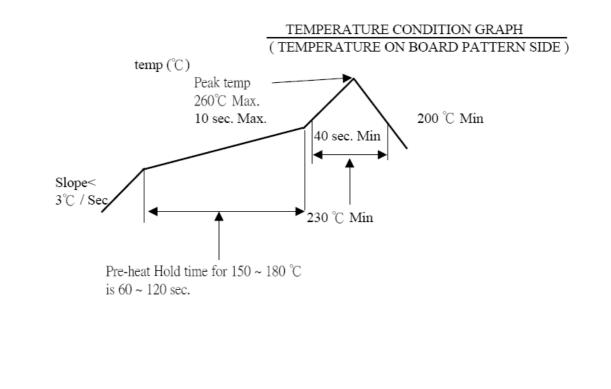
REVISION: A1 ECN No: ECN-011371

PAGE: 7 OF 8

Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)		
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (EIA-364-26)		
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5℃, for 4-5 sec. (EIA-364-52)		
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.		

Note. Flowing Mixed Gas shell be conduct by customer request.

6 INFRARED REFLOW CONDITION



TLE: 0.8mm H=15.0 mm BOARD TO		ONNE							<u></u> 0	07.0
EASE DATE: 2019/05/07 REVISION: A1			ECN	No: ECN	N-01137	1		PA	AGE: 8	OF 8
PRODUCT QUALIFICATION	AND TE	ST S	EQU	ENC	Ε					
Test Group										
Test or Examination	1	2	3	4	5	6	7	8	9	
				Т	est Se	quenc	e			
Examination of Product				1、7	1、6	1、4			1	
Low Level Contact Resistance		1 \ 5	1、4	2、10	2 • 9	2 \ 5			3	
Insulation Resistance				3、9	3、8					
Dielectric Withstanding Voltage				4 • 8	4 • 7					
Temperature rise	1									
Mating / Unmating Forces		2 \ 4								
Durability		3								
Contact Retention Force								1		
Vibration			2							
Shock (Mechanical)			3							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray(Only For Gold Plating)						3				
Solder ability							1			
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	4	2	4	4	